

	Page
<b>Type designation system</b> . . . . .	8
Type code . . . . .	8
Type marking . . . . .	9
Ordering code . . . . .	9
<b>Selection guide</b> . . . . .	12
Survey of types . . . . .	12
Application reference table . . . . .	14
Cross reference table of packages . . . . .	16
Types and ordering codes in alphanumerical order . . . . .	17
<b>Explanation of data sheet parameters</b> . . . . .	20
<b>Quality specifications</b> . . . . .	21
<b>Packaging</b> . . . . .	24
Taping: TO 92 package . . . . .	24
Taping: DO 35 package . . . . .	25
Taping: SMD packages (for surface mounting) . . . . .	26
<b>Mounting instructions</b> . . . . .	27
ESD-sensitive devices . . . . .	27
Heat dissipation . . . . .	27
Mechanical stress . . . . .	28
Soldering . . . . .	28
<b>Diodes — technical data</b> . . . . .	30
<b>Transistors — technical data</b> . . . . .	82